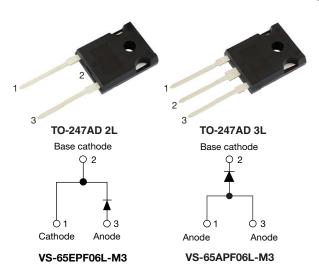


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Vishay Semiconductors

# Fast Soft Recovery Rectifier Diode, 65 A



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	65 A				
$V_{R}$	600 V				
V <sub>F</sub> at I <sub>F</sub>	1.32 V				
I <sub>FSM</sub>	830 A				
t <sub>rr</sub>	70 ns				
T <sub>J</sub> max.	150 °C				
Snap factor	0.5				
Package	TO-247AD 2L, TO-247AD 3L				
Circuit configuration	Single				

#### **FEATURES**

- Very low forward voltage drop and short reverse recovery time
- Glass passivated pellet chip junction
- Designed and qualified according to JEDEC® - JESD 47



- Flexible solution for reliable AC power rectification
- High surge, low V<sub>F</sub> rugged blocking diode for DC charging stations
- AEC-Q101 qualified P/N available (VS-65EPF06LHM3, VS-65APF06LHM3)
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### **APPLICATIONS**

These devices are intended for use in output rectification and freewheeling in inverters, choppers and converters as well as in input rectification where severe restrictions on conducted EMI should be met.

#### DESCRIPTION

The VS-65EPF06-M3 and VS-65APF06-M3 soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I <sub>F(AV)</sub>	Sinusoidal waveform	65	А			
V <sub>RRM</sub>		600	V			
I <sub>FSM</sub>		830	A			
t <sub>rr</sub>	1 A, 100 A /µs	70	ns			
V <sub>F</sub>	30 A, T <sub>J</sub> = 25 °C	1.1	V			
TJ		-40 to +150	°C			

VOLTAGE RATINGS						
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I <sub>RRM</sub> AT 150 °C mA			
VS-65EPF06L-M3	600	700	16			
VS-65APF06L-M3	600	700	10			

# **VS-65EPF06L-M3, VS-65APF06L-M3**

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum average forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 117 °C, 180° conduction half sine wave	65		
Maximum peak one cycle non-repetitive surge current	I <sub>FSM</sub>	10 ms sine pulse, rated V <sub>RRM</sub> applied	700	Α	
		10 ms sine pulse, no voltage reapplied	830		
Mar. 19. 121 for for the	l <sup>2</sup> t	10 ms sine pulse, rated V <sub>RRM</sub> applied	2450	A <sup>2</sup> s	
Maximum I <sup>2</sup> t for fusing		10 ms sine pulse, no voltage reapplied	3460	A-S	
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 ms to 10 ms, no voltage reapplied	34 600	A <sup>2</sup> √s	

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CON	DITIONS	VALUES	UNITS
Maximum forward voltage drop	V <sub>FM</sub>	65 A, T <sub>J</sub> = 25 °C		1.32	V
Forward slope resistance	r <sub>t</sub>	T <sub>J</sub> = 150 °C		5.0	mΩ
Threshold voltage	V <sub>F(TO)</sub>			0.88	V
Maximum roverse leakage ourrent	1	T <sub>J</sub> = 25 °C	V <sub>B</sub> = rated V <sub>BBM</sub>	0.1	mA
Maximum reverse leakage current	IRM	T <sub>J</sub> = 150 °C	v <sub>R</sub> = rated v <sub>RRM</sub>	16	IIIA

RECOVERY CHARACTERISTICS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	· •
Reverse recovery time	t <sub>rr</sub>	I⊏ at 60 A <sub>nk</sub>	180	ns	I <sub>FM</sub> t
Reverse recovery current	I <sub>rr</sub>	I <sub>F</sub> at 60 A <sub>pk</sub> 25 A/µs	3.4	Α	t <sub>a</sub> t <sub>b</sub>
Reverse recovery charge	Q <sub>rr</sub>	25 °C	0.5	μC	dir/ dt Q <sub>rr</sub>
Snap factor	S	Typical	0.5		I I <sub>RM(REC)</sub>

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and s temperature range	torage	T <sub>J</sub> , T <sub>Stg</sub>		-40 to +150	°C
Maximum thermal resista unction to case	ance,	$R_{thJC}$	DC operation	0.25	
Maximum thermal resistance, junction to ambient		R <sub>thJA</sub>		40	°C/W
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	Mounting surface, smooth, and greased	0.25	
Approximate weight				6	g
Approximate weight				0.21	OZ.
Mounting torque	Manustina taurus minimum			6 (5)	kgf · cm
maximun				12 (10)	(lbf ⋅ in)
Madina daria		Case style TO-247AD 2L 65EF		65EP	F06L
Marking device			Case style TO-247AD 3L	65AP	F06L



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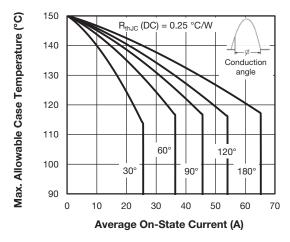


Fig. 1 - Current Rating Characteristics

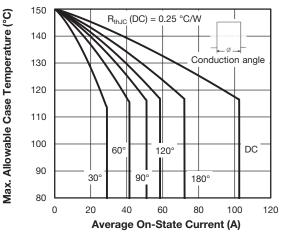


Fig. 2 - Current Rating Characteristics

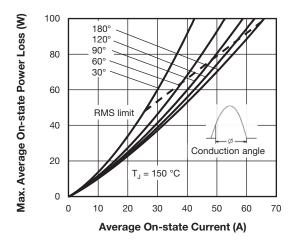


Fig. 3 - Forward Power Loss Characteristics

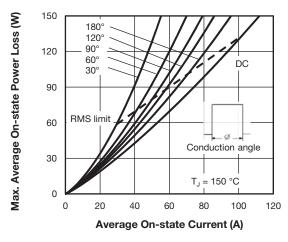


Fig. 4 - Forward Power Loss Characteristics

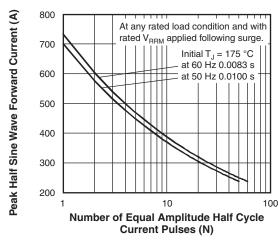


Fig. 5 - Maximum Non-Repetitive Surge Current

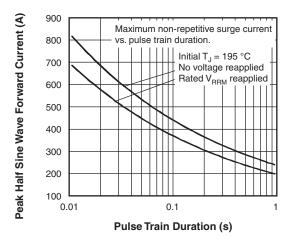


Fig. 6 - Maximum Non-Repetitive Surge Current



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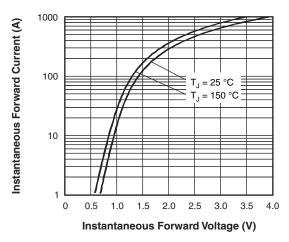


Fig. 7 - Forward Voltage Drop Characteristics

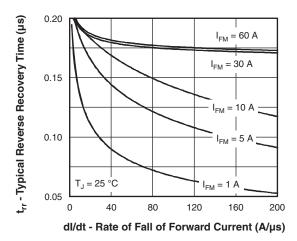


Fig. 8 - Thermal Impedance ZthJC Characteristics

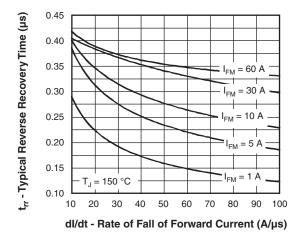


Fig. 9 - Recovery Time Characteristics,  $T_J$  = 150  $^{\circ}$ C

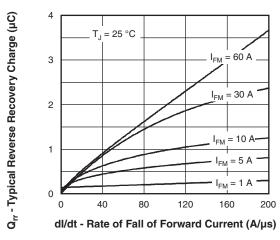


Fig. 10 - Recovery Charge Characteristics, T<sub>J</sub> = 25 °C

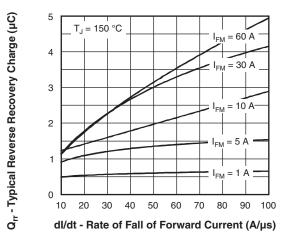


Fig. 11 - Recovery Charge Characteristics, T<sub>J</sub> = 150 °C

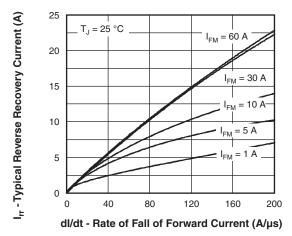


Fig. 12 - Recovery Current Characteristics,  $T_J = 25\ ^{\circ}\text{C}$ 



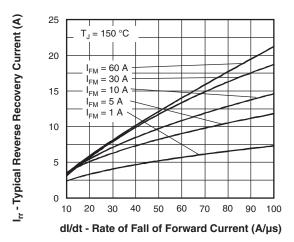


Fig. 13 - Recovery Current Characteristics, T<sub>J</sub> = 150 °C

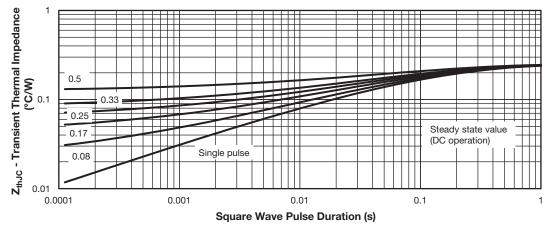


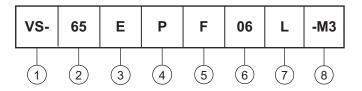
Fig. 14 - Thermal Impedance Z<sub>thJC</sub> Characteristics

# **VS-65EPF06L-M3, VS-65APF06L-M3**

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#### **ORDERING INFORMATION TABLE**

**Device code** 



Vishay Semiconductors product

2 - Current rating (65 = 65 A)

3 - Circuit configuration:

E = single, 2 pins

A = single, 3 pins

4 - Package:

P = TO-247AD

5 - Type of silicon:

F = fast recovery rectifier

7 - L = long leads

8 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION		
VS-65EPF06L-M3	25	500	Antistatic plastic tubes		
VS-65APF06L-M3	25	500	Antistatic plastic tubes		

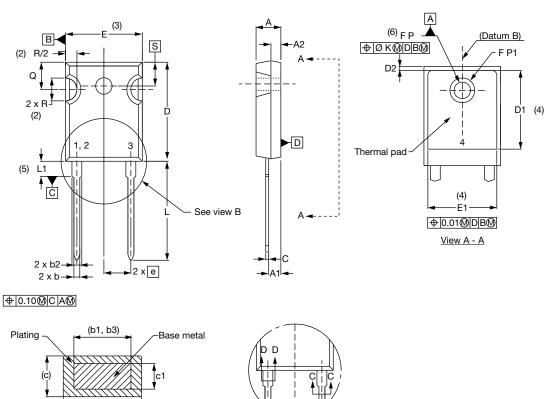
LINKS TO RELATED DOCUMENTS				
Dimensions	TO-247AD 2L	www.vishay.com/doc?95536		
Dimensions	TO-247AD 3L	www.vishay.com/doc?95626		
Part marking information	TO-247AD 2L	www.vishay.com/doc?95648		
Part marking information	TO-247AD 3L	www.vishay.com/doc?95007		



## Vishay Semiconductors

### **TO-247AD 2L**

#### **DIMENSIONS** in millimeters and inches



View B

SYMBOL	MILLIN	MILLIMETERS INCHES		NOTES	
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4
D2	0.51	1.35	0.020	0.053	

Section C - C, D - D

SYMBOL	MILLIN	MILLIMETERS		INCHES		
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
Е	15.29	15.87	0.602	0.625	3	
E1	13.46	-	0.53	-		
е	5.46	BSC	0.215	BSC		
ØK	0.254		0.0	10		
L	19.81	20.32	0.780	0.800		
L1	3.71	4.29	0.146	0.169		
ØΡ	3.56	3.66	0.14	0.144		
Ø P1	-	6.98	-	0.275		
Q	5.31	5.69	0.209	0.224		
R	4.52	5.49	0.178	0.216		
S	5.51 BSC 0.217 BSC					
	•		•	•		

#### **Notes**

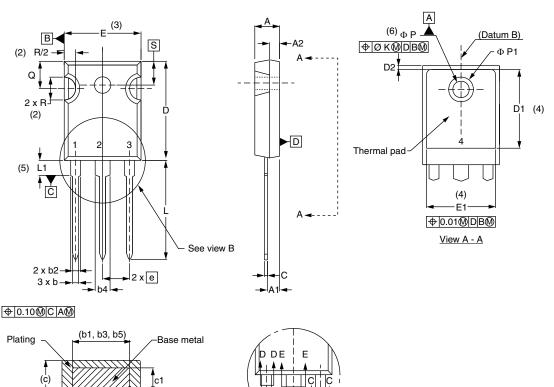
- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



## Vishay Semiconductors

### **TO-247AD 3L**

#### **DIMENSIONS** in millimeters and inches



View B

Section C - C, D - D, E - E						
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• •			0.050			

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b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46 BSC		0.215 BSC		
ØК	0.254		0.010		
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
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R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		
		<u> </u>	<u> </u>	<u> </u>	

#### Notes

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- (2) Contour of slot optional
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